



**THE DATASHEET OF  
EMT1DXV6T1G**



# EMT1DXV6

## Dual General Purpose Transistor

### PNP Dual

This transistor is designed for general purpose amplifier applications. It is housed in the SOT-563 which is designed for low power surface mount applications.

#### Features

- Lead-Free Solder Plating
- Low  $V_{CE(SAT)}$ ,  $< 0.5$  V
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

#### MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-Emitter Voltage	$V_{CEO}$	-60	V
Collector-Base Voltage	$V_{CBO}$	-50	V
Emitter-Base Voltage	$V_{EBO}$	-6.0	V
Collector Current - Continuous	$I_C$	-100	mAdc

#### THERMAL CHARACTERISTICS

Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation $T_A = 25^\circ\text{C}$	$P_D$	357 (Note 1)	mW
Derate above $25^\circ\text{C}$		2.9 (Note 1)	mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	350 (Note 1)	$^\circ\text{C}/\text{W}$
Characteristic (Both Junctions Heated)	Symbol	Max	Unit
Total Device Dissipation $T_A = 25^\circ\text{C}$	$P_D$	500 (Note 1)	mW
Derate above $25^\circ\text{C}$		4.0 (Note 1)	mW/ $^\circ\text{C}$
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	250 (Note 1)	$^\circ\text{C}/\text{W}$
Junction and Storage Temperature Range	$T_J, T_{stg}$	-55 to +150	$^\circ\text{C}$

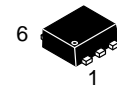
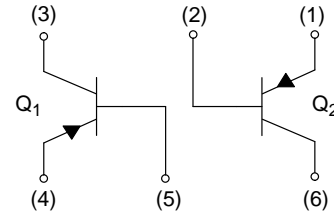
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. FR-4 @ Minimum Pad.



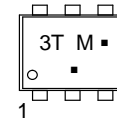
**ON Semiconductor**<sup>®</sup>

<http://onsemi.com>



**SOT-563  
CASE 463A  
STYLE 1**

#### MARKING DIAGRAM



3T = Specific Device Code  
M = Month Code  
■ = Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

# EMT1DXV6

## ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C)

Characteristic	Symbol	Min	Typ	Max	Unit
Collector–Base Breakdown Voltage (I <sub>C</sub> = –50 μAdc, I <sub>E</sub> = 0)	V <sub>(BR)CBO</sub>	–60	–	–	Vdc
Collector–Emitter Breakdown Voltage (I <sub>C</sub> = –1.0 mAdc, I <sub>B</sub> = 0)	V <sub>(BR)CEO</sub>	–50	–	–	Vdc
Emitter–Base Breakdown Voltage (I <sub>E</sub> = –50 μAdc, I <sub>E</sub> = 0)	V <sub>(BR)EBO</sub>	–6.0	–	–	Vdc
Collector–Base Cutoff Current (V <sub>CB</sub> = –30 Vdc, I <sub>E</sub> = 0)	I <sub>CBO</sub>	–	–	–0.5	nA
Emitter–Base Cutoff Current (V <sub>EB</sub> = –5.0 Vdc, I <sub>B</sub> = 0)	I <sub>EBO</sub>	–	–	–0.5	μA
Collector–Emitter Saturation Voltage (Note 2) (I <sub>C</sub> = –50 mAdc, I <sub>B</sub> = –5.0 mAdc)	V <sub>CE(sat)</sub>	–	–	–0.5	Vdc
DC Current Gain (Note 2) (V <sub>CE</sub> = –6.0 Vdc, I <sub>C</sub> = –1.0 mAdc)	h <sub>FE</sub>	120	–	560	–
Transition Frequency (V <sub>CE</sub> = –12 Vdc, I <sub>C</sub> = –2.0 mAdc, f = 30 MHz)	f <sub>T</sub>	–	140	–	MHz
Output Capacitance (V <sub>CB</sub> = –12 Vdc, I <sub>E</sub> = 0 Adc, f = 1 MHz)	C <sub>OB</sub>	–	3.5	–	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. Pulse Test: Pulse Width ≤ 300 μs, D.C. ≤ 2%.

## ORDERING INFORMATION

Device	Package	Shipping†
EMT1DXV6T1G	SOT–563 (Pb–Free)	4000 / Tape & Reel
NSVEMT1DXV6T1G*	SOT–563 (Pb–Free)	4000 / Tape & Reel
EMT1DXV6T5G	SOT–563 (Pb–Free)	8000 / Tape & Reel
NSVEMT1DXV6T5G*	SOT–563 (Pb–Free)	8000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

\*NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable.

# EMT1DXV6

## TYPICAL CHARACTERISTICS

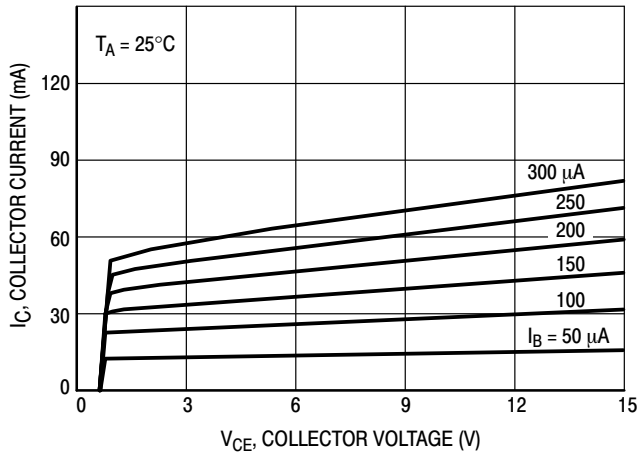


Figure 1.  $I_C - V_{CE}$

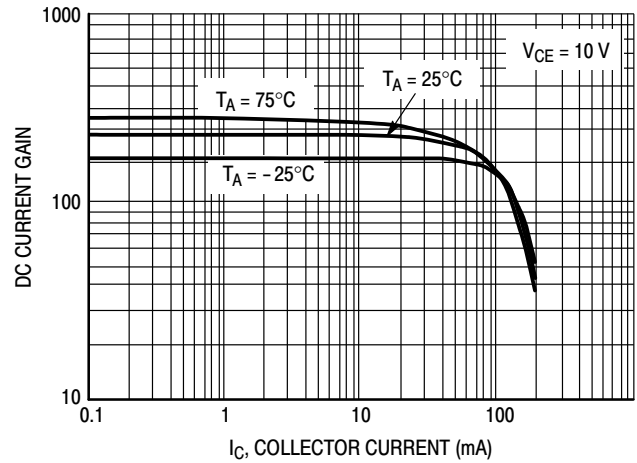


Figure 2. DC Current Gain

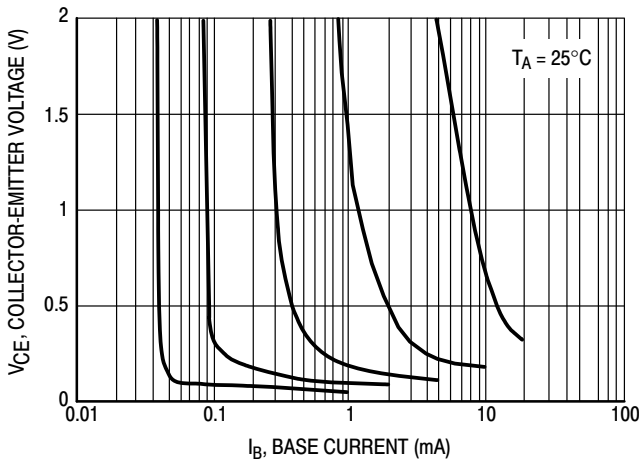


Figure 3. Collector Saturation Region

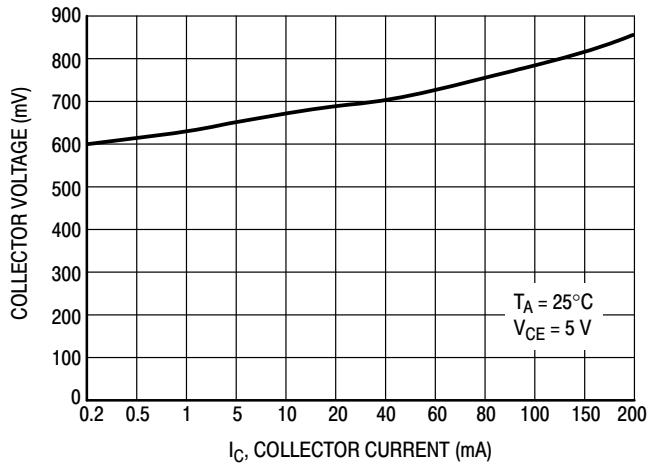


Figure 4. On Voltage

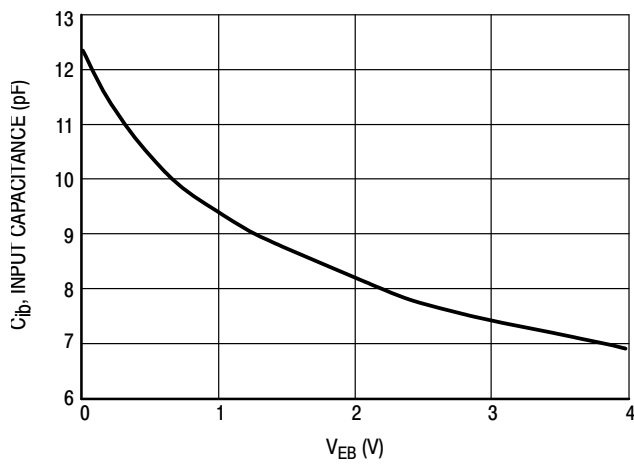


Figure 5. Capacitance

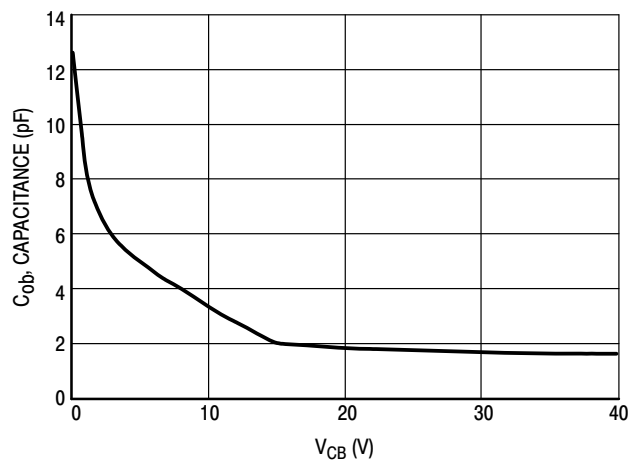
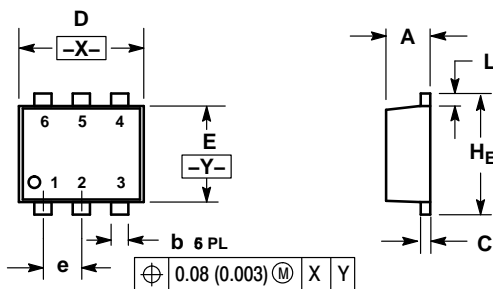


Figure 6. Capacitance

# EMT1DXV6

## PACKAGE DIMENSIONS

### SOT-563, 6 LEAD CASE 463A ISSUE F

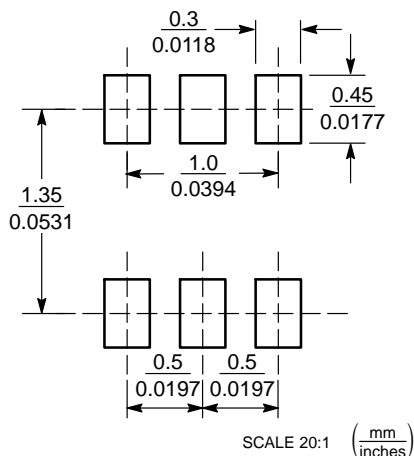


#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.50	0.55	0.60	0.020	0.021	0.023
b	0.17	0.22	0.27	0.007	0.009	0.011
C	0.08	0.12	0.18	0.003	0.005	0.007
D	1.50	1.60	1.70	0.059	0.062	0.066
E	1.10	1.20	1.30	0.043	0.047	0.051
e	0.5 BSC			0.02 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	1.50	1.60	1.70	0.059	0.062	0.066


#### SOLDERING FOOTPRINT\*



#### STYLE 1:

1. EMITTER 1
2. BASE 1
3. COLLECTOR 2
4. EMITTER 2
5. BASE 2
6. COLLECTOR 1

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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